2SC4953

Silicon NPN triple diffusion planar type

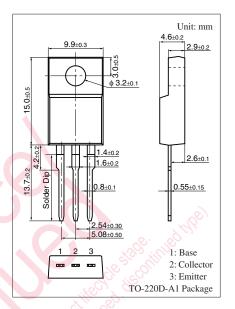
For high breakdown voltage high-speed switching

■ Features

- High-speed switching
- High collector-base voltage (Emitter open) V_{CBO}
- Wide safe operation area
- Satisfactory linearity of forward current transfer ratio h_{FE}
- Dielectric breakdown voltage of the package: > 5 kV

■ Absolute Maximum Ratings $T_a = 25$ °C

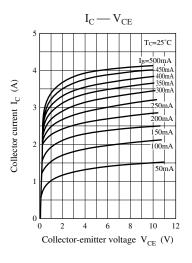
Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	500	V	
Collector-emitter voltage (E-B short)	V _{CES}	500	V	
Collector-emitter voltage (Base open)	V _{CEO}	400	V	
Emitter-base voltage (Collector open)	V_{EBO}	7	V	
Base current	I_{B}	1.2	А	
Collector current	$I_{\rm C}$	3	A	
Peak collector current	I_{CP}	6	A	
Collector power $T_C = 25^{\circ}C$	P _C	30	W	
dissipation		2.0		
Junction temperature	T_{j}	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

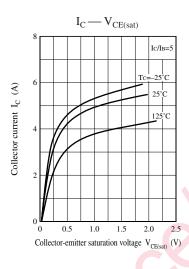


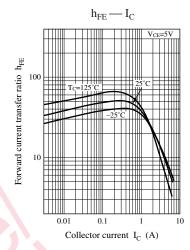
■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

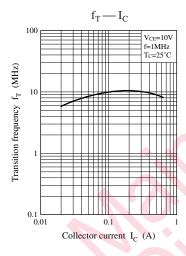
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 10 \text{ mA}, I_B = 0$	400			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 500 \text{ V}, I_E = 0$			100	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 5 \text{ V}, I_{C} = 0$			100	μΑ
Forward current transfer ratio	h _{FEI}	$V_{CE} = 5 \text{ V}, I_{C} = 0.1 \text{ A}$	10			_
	h_{FE2}	$V_{CE} = 2 \text{ V}, I_{C} = 1.2 \text{ A}$	8		40	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 1.5 \text{ A}, I_B = 0.3 \text{ A}$			1.0	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 1.5 \text{ A}, I_B = 0.3 \text{ A}$			1.5	V
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.2 \text{ A}, f = 1 \text{ MHz}$		10		MHz
Turn-on time	t _{on}	I _C = 1.5 A			1.0	μs
Storage time	t _{stg}	$I_{B1} = 0.15 \text{ A}, I_{B2} = -0.3 \text{ A}$			3.0	μs
Fall time	t _f	$V_{CC} = 200 \text{ V}$			0.3	μs

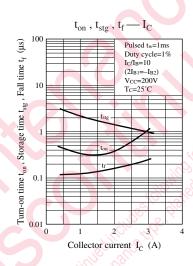
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

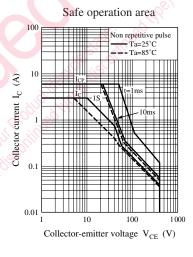


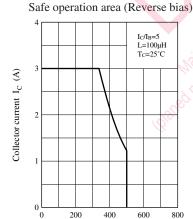












Collector-emitter voltage V_{CE} (V)

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